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2SC2979

Silicon NPN Triple Diffused

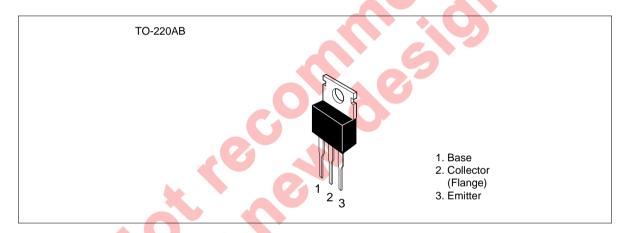


ADE-208-890 (Z) 1st. Edition September 2000

Application

High voltage, high speed and high power switching

Outline



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	900	V
Collector to emitter voltage	V _{CEO}	800	V
Emitter to base voltage	V_{EBO}	7	V
Collector current	Ic	3	A
Collector peak current	I _{C(peak)}	6	A
Base current	I _B	1.5	A
Collector power dissipation	P _c * ¹	40	W
Junction temperature	Тј	150	°C
Storage temperature	Tstg	-55 to +150	°C

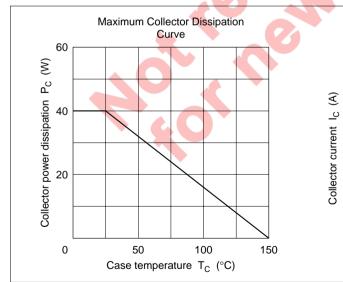
Note: 1. Value at $T_c = 25$ °C.

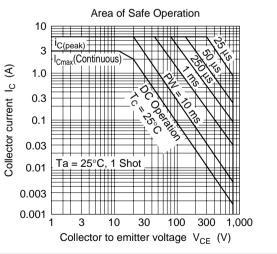
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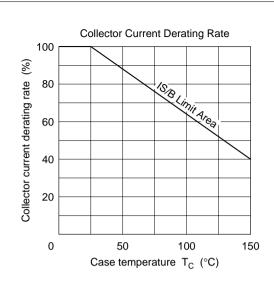
Electrical Characteristics (Ta = 25°C)

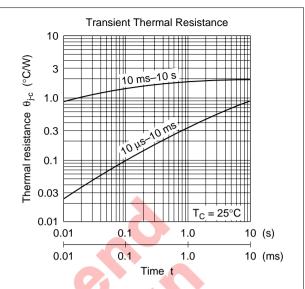
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to emitter sustain voltage	$V_{\text{CEO(sus)}}$	800	_	_	V	$I_{C} = 0.2 \text{ A}, R_{BE} = \infty, L = 100 \text{ mH}$
	$V_{\text{CEX(sus)}}$	800	_	_	V	$I_{\text{C}}=3$ A, $I_{\text{B1}}=0.9$ A, $I_{\text{B2}}=-0.6$ A, $V_{\text{BE}}=-5.0$ V, L = 180 $\mu\text{H},$ Clamped
Emitter to base breakdown voltage	$V_{(BR)EBO}$	7	_	_	V	$I_{\rm E} = 10 \text{ mA}, I_{\rm C} = 0$
Collector cutoff current	I _{CBO}	_	_	100	μΑ	$V_{CB} = 750 \text{ V}, I_{E} = 0$
	I _{CEO}	_	_	100	μΑ	$V_{CE} = 650 \text{ V}, R_{BE} = \infty$
DC current transfer ratio	h _{FE1}	15	_	_		$V_{CE} = 5 \text{ V}, I_{C} = 0.3 \text{ A}^{*1}$
	h _{FE2}	7	_	_		$V_{CE} = 5 \text{ V}, I_{C} = 1.5 \text{ A}^{*1}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	1.0	V	$I_{\rm C} = 0.75 \text{ A}, I_{\rm B} = 0.15 \text{ A}^{*1}$
Base to emitter saturation voltage	$V_{BE(sat)}$	_	-	1.5	V	O)
Turn on time	t _{on}	_	-	1.0	μs	$I_C = 1.5 \text{ A}, I_{B1} = 0.3 \text{ A},$
Storage time	t _{stg}		4	3.0	μs	$I_{B2} = -0.75 \text{ A}, V_{CC} \cong 250 \text{ V}$
Fall time	t _f	-(1.0	μs	

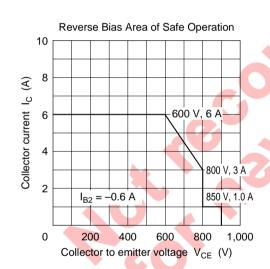
Note: 1. Pulse test

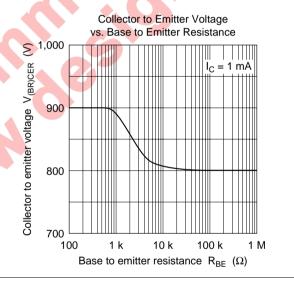


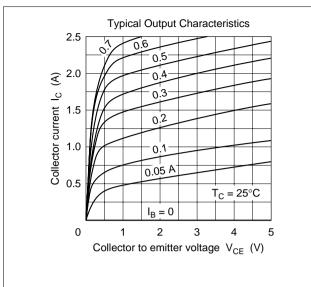


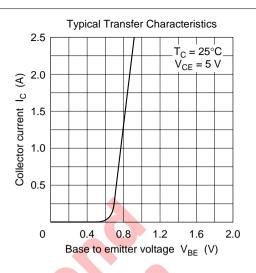


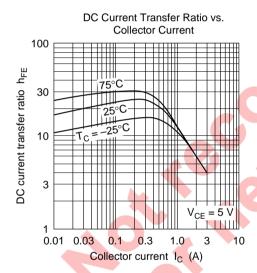


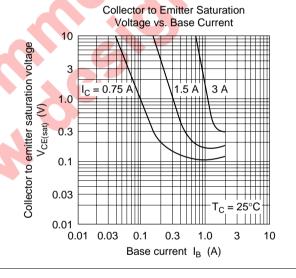


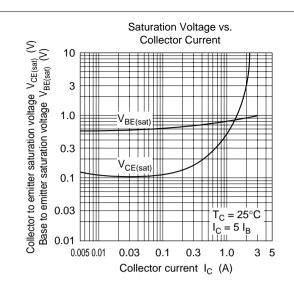


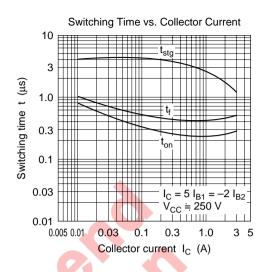


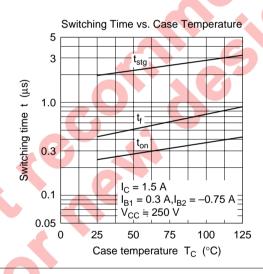












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